

Features

- 2.15×2.40mm with 1.80mm lens
- High Brightness
- Water Clear
- Small double-end package
- EIA Std. package
- Mono-color type
- Special packaging available upon request
- High reliability

Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

Description

The INA-912AHIR25.GR is high brightness SMD Axial LED. It is a 1.8mm Lens type LED which can be used in various applications.

Recommended Solder Pattern

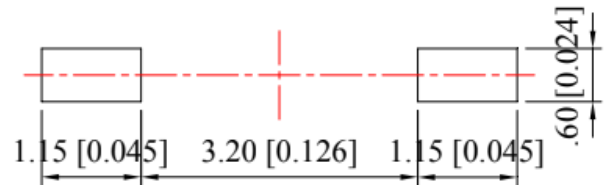


Figure 1. INA-912AHIR25.GR Solder Pattern

Package Dimensions in mm

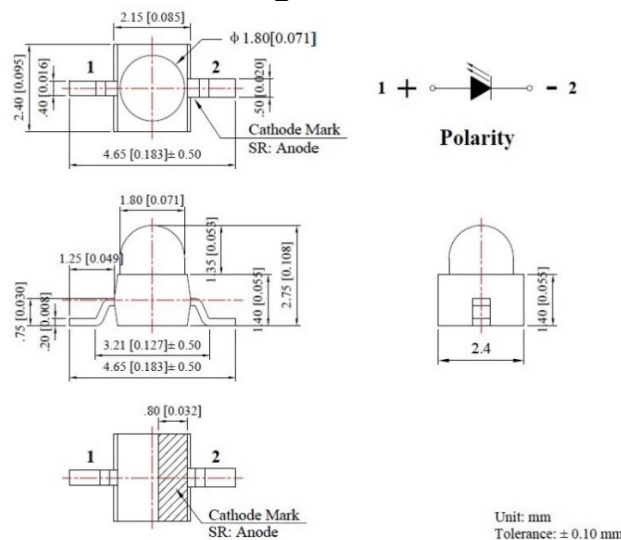


Figure 2. INA-912AHIR25.GR Package Dimensions

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.

Absolute Maximum Rating at 25°C (Note)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (A)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)
INA-912AHIR25.GR	Infrared	90	50	1.00	5	-40°C~+80°C	-40°C~+85°C

Notes

1. Derate linearly as shown in derating curve.
2. Duty Factor = 10%, Frequency = 1 kHz

Electrical Characteristics T_A = 25°C (Note)

Product	Emission Color	I _F (mA)	V _F (V)						λ(nm)			Viewing Angle	E _e (mW/sr)					
			IF=20mA			IF=100mA, tp=100μs, tp/T=0.01			λ _D	λ _P	Δλ	2θ1/2	IF=20mA			IF=100mA, tp=100μs, tp/T=0.01		
			min	typ	max	min	typ	max					min	typ	max	min	typ	max
INA-912AHIR25.GR	Infrared	20	0.8	1.2	1.5	-	1.6	1.8	-	940	50	25	3	6	-	-	15	-

Notes

1. Performance guaranteed only under conditions listed in above tables.
2. A luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
3. 2θ1/2 is the o -axis angle where the luminous intensity is 1/2 the peak intensity.
4. The dominant wavelength (λ_D) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection

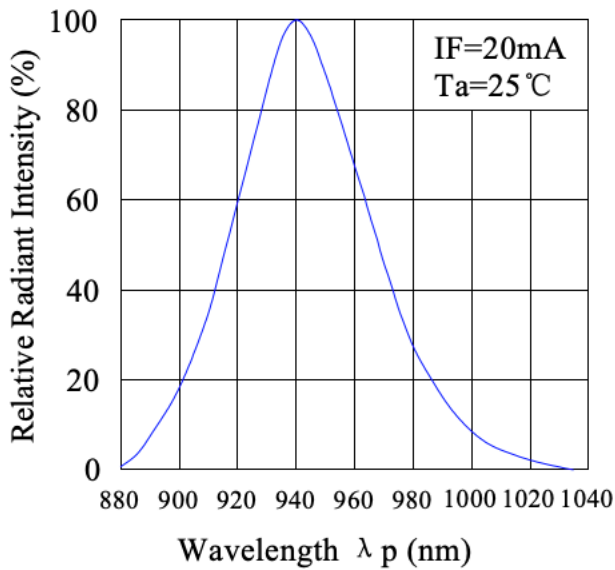


The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

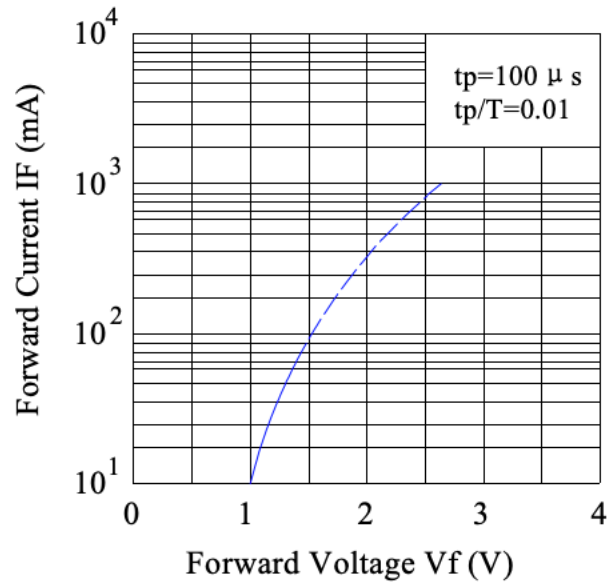
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Typical Characteristic Curves Infrared

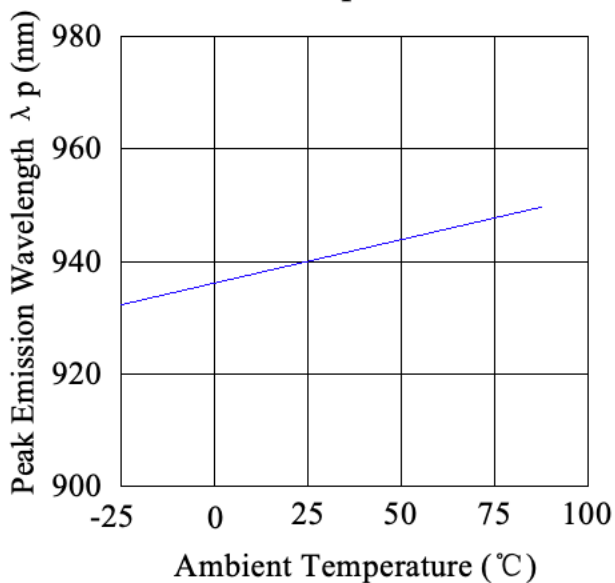
Spectral Distribution



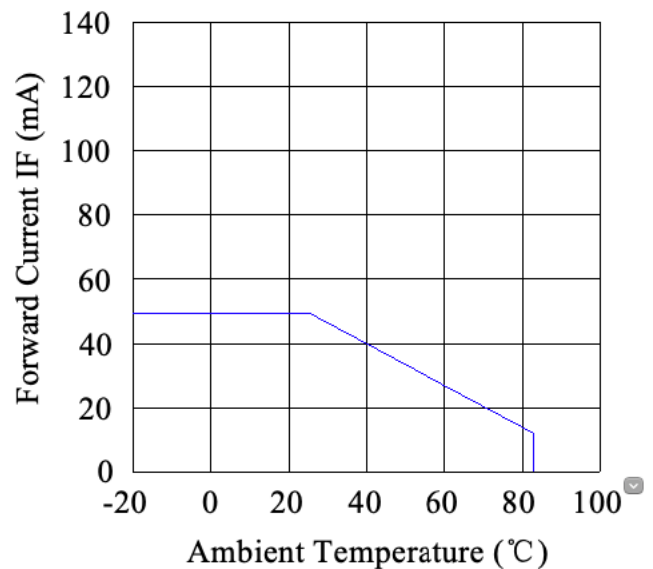
Forward Current & Forward Voltage

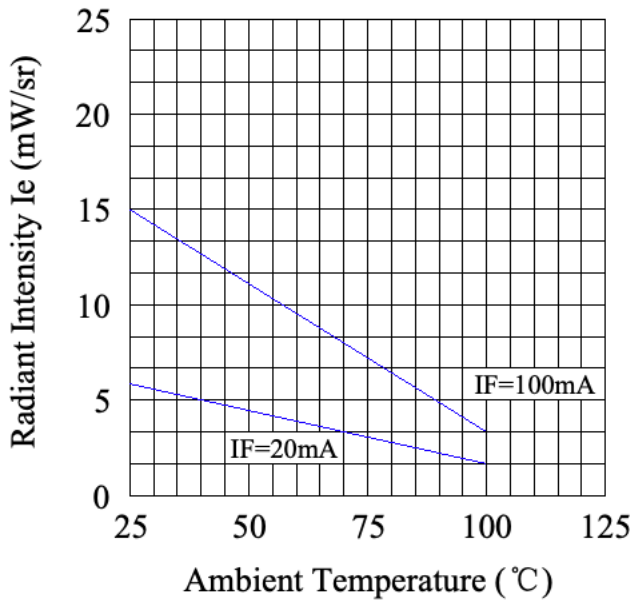
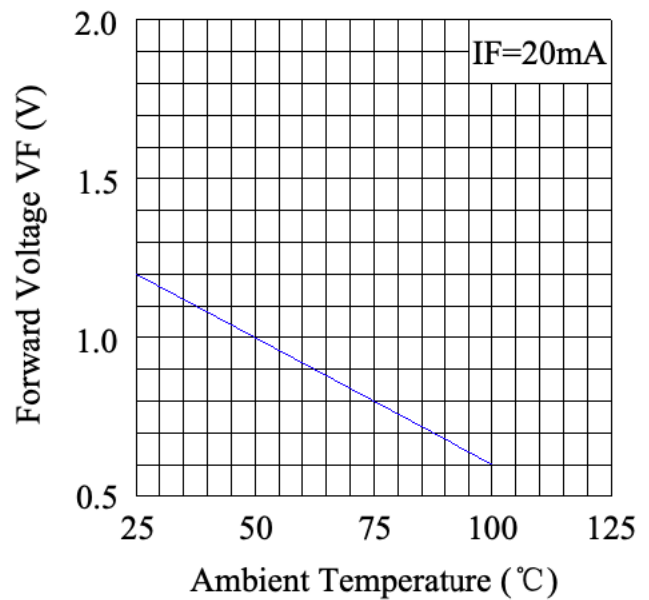
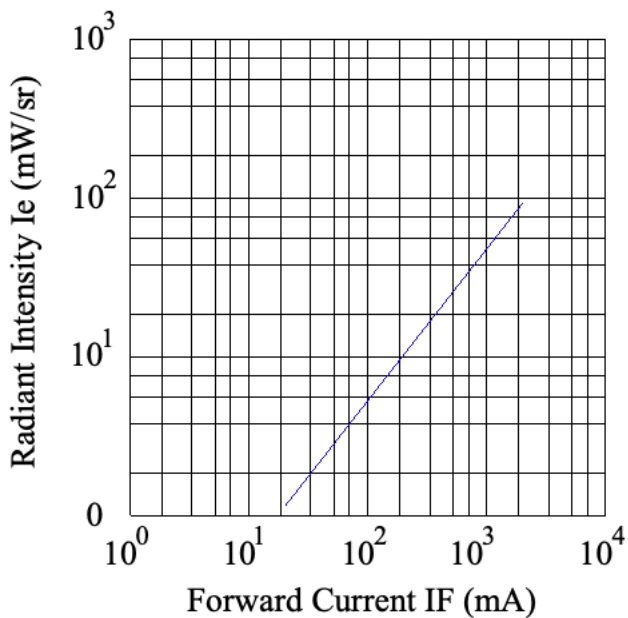
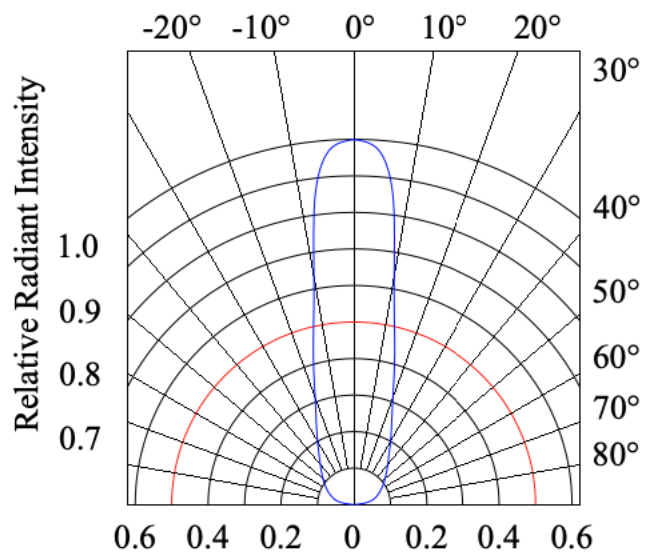


Peak Emission Wavelength & Ambient Temperature



Forward Current & Ambient Temperature





Relative Intensity & Ambient Temperature

Forward Voltage & Ambient Temperature

Relative Intensity & Forward Current

Relative Radiant Intensity & Angular Displacement


Ordering Information

Product	Emission Color	Test Current I_F (mA)	Radiant Intensity E_e (mW/sr) (Typ.)		Forward Voltage VF (V) (Typ.)		Orderable Part Number
			IF=20mA	IF=100mA, tp=100µs, tp/T=0.01	IF=20mA	IF=100mA, tp=100µs, tp/T=0.01	
INA-912AHIR25.GR	Infrared	20	6	15	1.2	1.6	INA-912AHIR25.GR

Label Specifications

		Date: yyyy/mm/dd
CUSTOMER P/N: 		
INOLUX P/N: 	QTY: PCS 	
LOT NO: 		QC
IV BIN: COLOR BIN: VF:		

Inolux P/N:

I	N	A	-	912	A		HIR	25	.GR	X	X	X	X
Inolux Lead frame Axial				Package	Lens	Color	View Angle	Leadframe type	Customized Stamp-off				
				912A = Lead frame Axial	(Blank) = Clear Lens	HIR = 940nm	25 = 25 deg.	GR = Gullwing					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125µs,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-27-2021
Image Revision		1.1	04-14-2022

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.